# **Specifications for Approval**

Customer Part No.:

Inhere Part No.: S2106JSWD-002

Part Name: 2106 白光 LED

Spec Issue Date: 2018-07-15

**Revision No.: A** 

Ve submit herewitl	n the following inform	ation for your app	proval:
■Sample	□OQC Inspection	Record	LED Dimension
Electrical Chara	acteristics Curve	Internal Cir	cuit Diagram
Soldering reco	mmendation		
Prepared by: Lily	Checke	ed by: Tom	Approved by: Wangxiaojun
Date: 2018-07-15	Date: 2	2018-07-15	Date: 2018-07-15

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Reject with the following reason:



东莞市银河光电有限公司 DongGuan Inhere Opto CO.,LTD. 地址:东莞市莞城科技园D幢 ADD:Guancheng Science & Technology Park, DongGuan TEL: 0769-23320868 FAX: 0769-23320878 E-mail: bill@inhereopto.com Http://www.inhereopto.com

## Features

2.1mm X 0.6mm SMD LED, 1.0mm thickness

Low power consumption

Wide view angle

Package: 4000pcs/reel

**RoHS** Compliant

# Applications

1

1.00 [0.04"]

1

Ideal for back light and indicator

Various colors and lens types available

# Package outlines

# 0.80 [0.03" 2.10 [0.08"] 1.00 [0.04"] 0.60 [0.02" 1.50 [0.06"] 2 1.70 [0.07"] 3.50 [0.14"] 50 [0.02] **ATTENTION** 1.50 [0.06"] OBSERVE PRECAUTIONS FOR HANDLING 2 ELECTROSTATIC SENSITIVE DEVICES -02 10-

Part No.	Emitted color	Dice	Lens color
S2106JSWD-002	White	InGaN/GaN	Yellow

Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are  $\pm 0.1$ mm (0.004inch) unless otherwise noted.

**Recommend Pad Layout** 

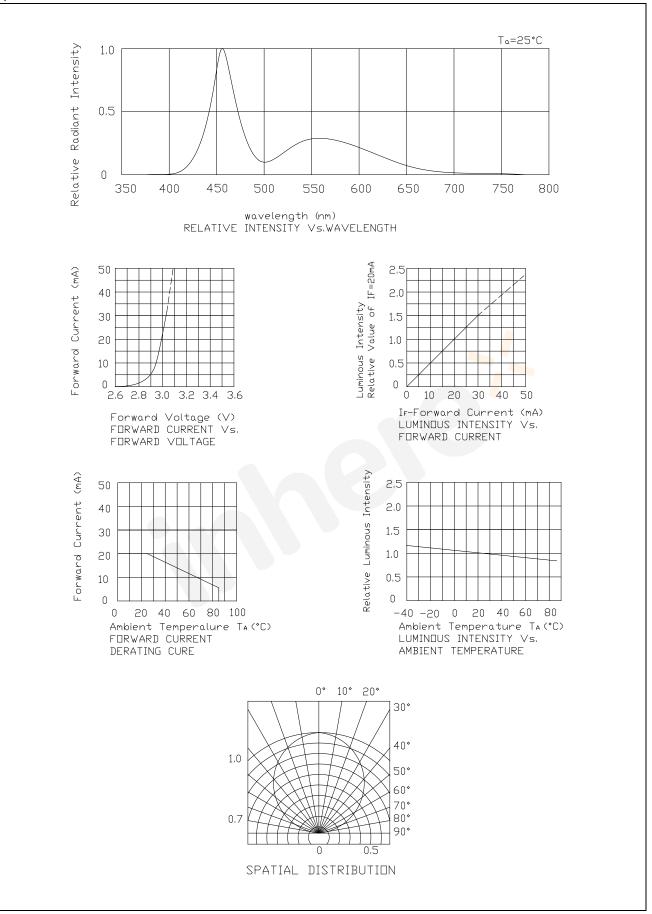
Absolute	Maximum	Ratings	(Ta=25℃)
Absolute	IVIAXIIIIUIII	natings (	1a-25 C)

Parameter	Symbol	Value	Unit		
Forward current	lf	30	mA		
Reverse voltage	Vr	5	V		
Power dissipation	Pd	108	mW		
Operating temperature	Тор	-40 ~+80	°C		
Storage temperature	Tstg	-40 ~+85	°C		
Peak pulsing current (1/8 duty f=1kHz)	lfp	125	mA		
Electro-Optical Characteristics (Ta=25°C)					

# Electro-Optical Characteristics (Ta=25°C)

	Test		Value			
Parameter	Condition	Symbol	Min	Тур	Max	Unit
CIE Coordinates	lf-20m4	х	0.2927		0.3513	
CIE COORUINALES	lf=20mA	Y	0.3100		0.4036	
Forward voltage	lf=20mA	Vf	2.8		3.6	v
Luminous intensity	lf=20mA	lv	400	570		mcd
Viewing angle at 50% lv	lf=10mA	2 <sup>θ</sup> 1/2		110		Deg
Reverse current	Vr=5V	lr			10	μΑ

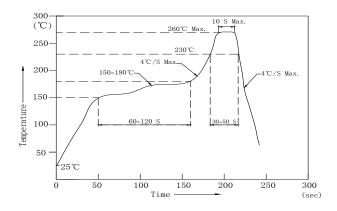
#### **Optical Characteristic Curves**



Rev.: A Checked by: Tom

# **Reflow Profile**

■ Reflow Temp/Time



# Notes:

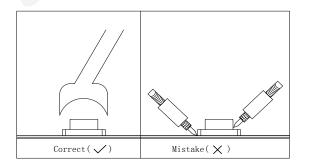
- 1. We recommend the reflow temperature 245  $^{\circ}$ C (±5  $^{\circ}$ C).the maximum soldering temperature should be limited to 260  $^{\circ}$ C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

# ■Soldering iron

Basic spec is ≤ 5sec when 320°C (±20°C). If temperature is higher, time should be shorter (+10°C→ -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 350°C.

#### Rework

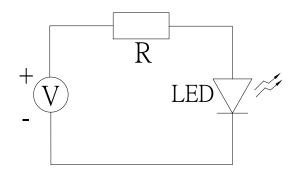
- 1. Customer must finish rework within 5 sec under 340°C.
- 2. The head of iron cannot touch copper foil
- 3. Twin-head type is preferred.



Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

### Test circuit and handling precautions

Test circuit



#### Handling precautions

# 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

# 2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature: 5°C~30°C

- 2.2 Shelf life in sealed bag: 12 month at  $<5^{\circ}C^{\sim}30^{\circ}C$  and <30% R.H. after the package is opened, the products should be used within a week or they should be keeping to stored at  $\leq$  20 R.H. with zip-lock sealed.
- 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as followings:

- 3.1 60±3°C x (12~24hrs) and <5%RH, taped reel type
- 3.2 100±3°C x (45min~1hr), bulk type
- 3.3 130±3°C x (15~30min), bulk type

# Test Items and Results of Reliability

Test Item	Test Conditions	Standard Test Method	Note	Number of Test
Reflow Soldering	Ta=260±5 ℃,Time=10±2S	JB/T 10845-2008	3times	0/22
Salt Atmosphere	Ta=35±3℃,PH=6.5~7.2	GB/T 2423.17-2008	24hrs	0/22
Temperature Cycling	-40±5℃ 30±1min 个→(25℃/5±1min)↓ 100±5℃ 30±1min	GB/T 2423.22-2012	100cycles	0/22
Thermal Shock	Ta=-40±5℃ $\sim$ 100±5℃, 15±1min dwell	GB/T 2423.22-2012	100cycles	0/22
High Humidity High Temp. Cycling	Ta=30±5℃~65±5℃, 90±5%RH,24hrs/1cycle	GB/T 2423.4-2008	10cycles	0/22
High Humidity High Temp. Storage Life	Ta=85±5°C,ψ(%)=85±5%RH	GB/T 2423.3-2006	1000hrs	0/22
High Temperature Storage Life	Ta=100±5℃,non-operating	GB/T 2423.2-2008	1000hrs	0/22
Low Temperature Storage Life	Ta=-40±5℃,non-operating	GB/T 2423.1-2008	1000hrs	0/22
Life Test	Ta=26±5℃,@20mA, ψ(%)=25%RH~55%RH		1000hrs	0/22
High Humidity High Temp. Operating Life	Ta=85±5℃,@20mA, ψ(%)=85%RH	GB/T 2423.3-2006	500hrs	0/22
Low Temperature Operating Life	Ta=-20±5℃,@20mA	GB/T 2423.1-2008	1000hrs	0/22

# Forward Voltage Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
Н	2.8	2.9	
I	2.9	3.0	
J	3.0	3.1	
К	3.1	3.2	
L	3.2	3.3	V
М	3.3	3.4	
Ν	3.4	3.5	
0	3.5	3.6	
Luminous Intensity Rank Co	mbination (IF=20mA)		

# Luminous Intensity Rank Combination (IF=20mA)

Rank	Min.	Max.	Unit
Р	400	500	
Q	500	630	
R	630	800	mcd
S	800	1000	
т	1000		

# Chromaticity coordinates Ranks combination (IF=20mA)

Rank		Chromaticity coordinates						
05	x	0.3060	0.3028	0.3156	0.3172			
C5	Y	0.3100	0.3239	0.3418	0.3257			
66	x	0.3028	0.2997	0.3139	0.3156			
C6	Y	0.3239	0.3379	0.3578	0.3418			
<u></u>	x	0.3172	0.3155	0.3272	0.3276			
C8	Y	0.3257	0.3418	0.3581	0.3402			
С9	x	0.3156	0.3139	0.3269	0.3272			
CS	Y	0.3418	0.3578	0.3760	0.3581			
D2	х	0.3276	0.3272	0.3365	0.3360			
D2	Y	0.3402	0.3581	0.3711	0.3519			
D3	x	0.3272	0.3269	0.3371	0.3365			
05	Y	0.3581	0.3760	0.3903	0.3711			
D6	x	0.3360	0.3365	0.3490	0.3468			
00	Y	0.3519	0.3711	0.3839	0.3641			
D7	x	0.3365	0.3371	0.3513	0.3490			
	Y	0.3711	0.3903	0.4036	0.3839			

# Group Name on Label (Example DATA: I Q C8 20)

DATA: I Q C8 20	Vf(V)	lv (mcd)	CIE(X,Y)	Test Condition
I→Q→C8→20	2.9~3.0	500~630	X(0.3155~0.3276),Y(0.3257~0.3581)	IF=20mA

Notes:

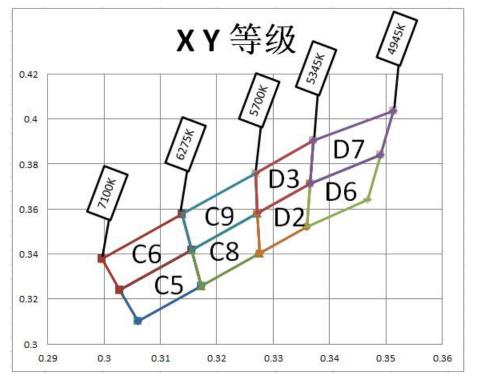
1.The tolerance of luminous intensity (Iv )is  $\pm 15~\%$  .

2. The tolerance of CIE Coordinates(X,Y)  $\pm$  0.01.

3. This specification is preliminary.

4. This specification is a standard specification of our factory, can make in accordance with customer's special requirement.

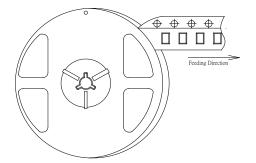
#### XY chromaticity coordinate

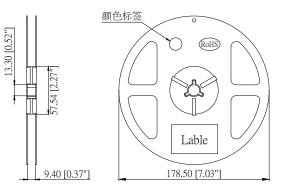


#### 2106 Series SMD Chip LED Lamps Packaging Specifications

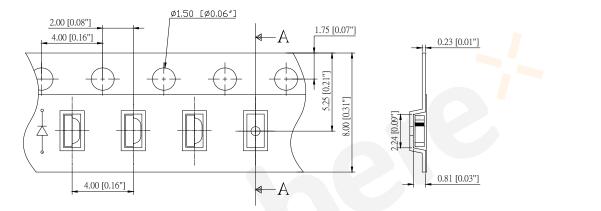
Feeding Direction

• Dimensions of Reel (Unit: mm)

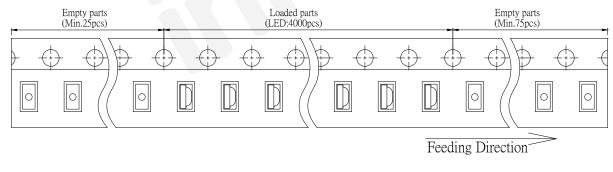


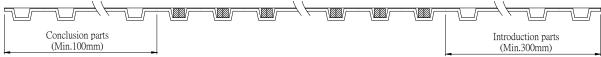


# • Dimensions of Tape (Unit: mm)



#### Arrangement of Tape



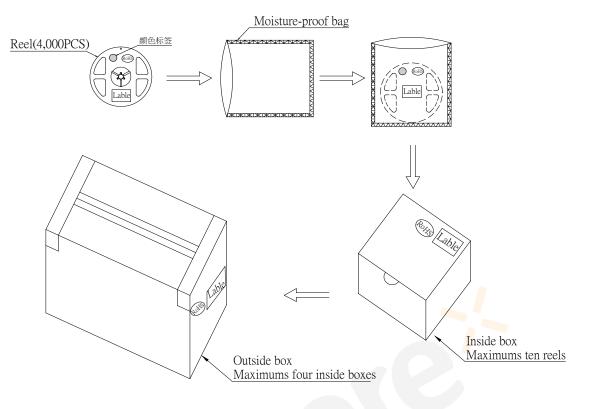


#### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications.
- 4. 4,000pcs/Reel.

#### 2106 Series SMD Chip LED Lamps Packaging Specifications

### • Packaging specifications



Notes:

Reeled products (numbers of products are 4,000pcs) packed in a seal off moisture-proof bag along with a desiccant one by one, ten moisture-proof bag of maximums (total maximum number of products are 40,000pcs) packed in an inside box (about size: 240x 230x 130mm) and four inside boxes of maximums are put in the outside box (about size: 545mm x 260mm x 250mm) Together with buffer material, and it is packed. (Part No., Lot No., quantity should appear on the label on the moisture-proof bag, part No. And quantity should appear on the label on the cardboard box.) The number of the loading steps of outside box (cardboard box) has it to three steps.